

ABSTRACT OF THE DISCLOSURE

MANUFACTURING PROCESS OF DETACHABLE SUBSTRATES

The invention relates to a manufacturing process of detachable substrates, the said process comprising a surface condition adjustment treatment of at least one of two layers of material, followed by the reversible
5 bonding of the surfaces of the two layers to make the detachable substrate, characterised in that the said surface condition adjustment treatment comprises the bombardment of the surface to be treated with ion clusters.

10

FIGURE 2b